

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yu-Jin Lee</td> <td>07/30/2013</td> </tr> <tr> <td>Han-Jun Ku</td> <td>07/30/2013</td> </tr> <tr> <td>Han-Kyung Jeon</td> <td>07/30/2013</td> </tr> <tr> <td>Seung-Hwan Cho</td> <td>07/30/2013</td> </tr> </tbody> </table>		Name	Execution Date	Yu-Jin Lee	07/30/2013	Han-Jun Ku	07/30/2013	Han-Kyung Jeon	07/30/2013	Seung-Hwan Cho	07/30/2013
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Yu-Jin Lee	07/30/2013										
Han-Jun Ku	07/30/2013										
Han-Kyung Jeon	07/30/2013										
Seung-Hwan Cho	07/30/2013										
RECEIVING PARTY DATA											
Name:	Samsung Electronics Co., Ltd										
Street Address:	129, Samsung-ro										
Internal Address:	Yeongtong-gu, Suwon-si										
City:	Gyeonggi-do										
State/Country:	KOREA, REPUBLIC OF										
Postal Code:	443-742										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14011632</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14011632						
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Application Number:	14011632										
CORRESPONDENCE DATA											
Fax Number:	9726283616										
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NAME OF SUBMITTER:	William A. Munck										
Signature:	/William A. Munck/										

CH \$40.00 14011632

Date:

08/27/2013

Total Attachments: 2

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ASSIGNMENT

WHEREAS, We, **Yu-Jin Lee**, resident of Seocho-gu, Seoul, Republic of Korea, citizen of Republic of Korea, **Han-Jun Ku**, resident of Suwon-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, **Han-Kyung Jeon**, resident of Anyang-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, and **Seung-Hwan Cho**, resident of Yongin-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, have invented certain new and useful improvements in a "METHOD AND APPARATUS FOR PROVIDING USER INTERFACE" disclosed in an application for United States Letters Patent (Application Serial No. ___/_____, filed on _____, said application having been executed concurrently herewith;


WHEREAS, SAMSUNG ELECTRONICS CO., LTD, a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 443-742, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

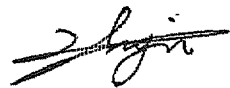
We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: July 30th, 2013




Yu-Jin Lee

Date: July 30th, 2013



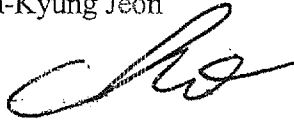
Han-Jun Ku

Date: July 30th, 2013



Han-Kyung Jeon

Date: July 30th, 2013



Seung-Hwan Cho